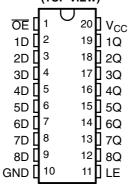
# SN54BCT573, SN74BCT573 OCTAL TRANSPARENT D-TYPE LATCHES WITH 3-STATE OUTPUTS

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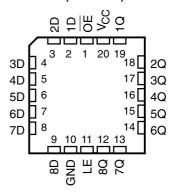
- Operating Voltage Range of 4.5 V to 5.5 V
- State-of-the-Art BiCMOS Design Significantly Reduces I<sub>CCZ</sub>
- Full Parallel Access for Loading

SN54BCT573 . . . J OR W PACKAGE SN74BCT573 . . . DW, N, OR NS PACKAGE (TOP VIEW)



- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

SN54BCT573 . . . FK PACKAGE (TOP VIEW)



#### description/ordering information

These 8-bit latches feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

The eight latches of the 'BCT573 devices are transparent D-type latches. While the latch-enable (LE) input is high, the Q outputs follow the data (D) inputs. When the latch enable is taken low, the Q outputs are latched at the logic levels that were set up at the D inputs.

A buffered output-enable  $(\overline{OE})$  input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without interface or pullup components.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

OE does not affect internal operations of the latches. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

#### ORDERING INFORMATION

T <sub>A</sub>	PACKA	GE <sup>†</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – N	Tube	SN74BCT573N	SN74BCT573N
0°C to 70°C	COIC DW	Tube	SN74BCT573DW	DOTE 70
	SOIC - DW	Tape and reel	SN74BCT573DWR	BCT573
	SOP – NS Tape and reel		SN74BCT573NSR	BCT573
	CDIP – J	Tube	SNJ54BCT573J	SNJ54BCT573J
–55°C to 125°C	CFP – W Tube		SNJ54BCT573W	SNJ54BCT573W
	LCCC - FK	Tube	SNJ54BCT573FK	SNJ54BCT573FK

<sup>&</sup>lt;sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



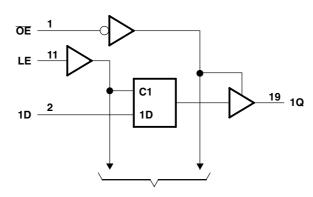
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# FUNCTION TABLE (each latch)

	INPUTS	OUTPUT	
ŌĒ	LE	D	Q
L	Н	Н	Н
L	Н	L	L
L	L	Χ	$Q_0$
Н	X	Χ	Z

### logic diagram (positive logic)



To Seven Other Channels

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	–0.5 V to 7 V
Input voltage range, V <sub>I</sub> (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the disabled or power-off state, Vo	
Voltage range applied to any output in the high state, VO	0.5 V to V <sub>CC</sub>
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)	
Current into any output in the low state: SN54BCT573	
SN74BCT573	
Package thermal impedance, θ <sub>JA</sub> (see Note 2): DW package	58°C/W
N package	69°C/W
NS package	60°C/W
Storage temperature range, T <sub>stg</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
  - 2. The package thermal impedance is calculated in accordance with JESD 51-7.



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### recommended operating conditions (see Note 3)

		SN54BCT573			SN	LINUT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
$V_{CC}$	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
$V_{IH}$	High-level input voltage	2			2			V
$V_{IL}$	Low-level input voltage			0.8			0.8	V
I <sub>IK</sub>	Input clamp current			-18			-18	mA
I <sub>OH</sub>	High-level output current			-12			-15	mA
I <sub>OL</sub>	Low-level output current			48			64	mA
T <sub>A</sub>	Operating free-air temperature	-55		125	0		70	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

24244555		SN	54BCT5	73	SN				
PARAMETER	IEST	CONDITIONS	MIN	TYP†	MAX	MIN	TYP†	MAX	UNIT
V <sub>IK</sub>	$V_{CC} = 4.5 \text{ V},$	I <sub>I</sub> = -18 mA			-1.2			-1.2	V
		$I_{OH} = -3 \text{ mA}$	2.4	3.3		2.4	3.3		
$V_{OH}$	V <sub>CC</sub> = 4.5 V	$I_{OH} = -12 \text{ mA}$	2	3.2					V
		$I_{OH} = -15 \text{ mA}$				2	3.1		
.,	V 45V	$I_{OL} = 48 \text{ mA}$		0.38	0.55				٧
$V_{OL}$	$V_{CC} = 4.5 \text{ V}$	$I_{OL} = 64 \text{ mA}$					0.42	0.55	<b>V</b>
I <sub>I</sub>	$V_{CC} = 5.5 V,$	V <sub>I</sub> = 5.5 V			0.4			0.4	mA
I <sub>IH</sub>	$V_{CC} = 5.5 \text{ V},$	$V_{I} = 2.7 \text{ V}$			20			20	μΑ
I <sub>IL</sub>	$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 0.5 V			-0.6			-0.6	mA
I <sub>OS</sub> ‡	$V_{CC} = 5.5 \text{ V},$	V <sub>O</sub> = 0	-100		-225	-100		-225	mA
I <sub>OZH</sub>	$V_{CC} = 5.5 \text{ V},$	V <sub>O</sub> = 2.7 V			50			50	μΑ
I <sub>OZL</sub>	$V_{CC} = 5.5 \text{ V},$	V <sub>O</sub> = 0.5 V			-50			-50	μΑ
I <sub>CCL</sub>	$V_{CC} = 5.5 \text{ V},$	Outputs open			62			62	mA
I <sub>CCH</sub>	$V_{CC} = 5.5 \text{ V},$	Outputs open			8			8	mA
I <sub>CCZ</sub>	$V_{CC} = 5.5 \text{ V},$	Outputs open			8			8	mA
C <sub>i</sub>	V <sub>CC</sub> = 5 V,	V <sub>I</sub> = 2.5 V or 0.5 V		5.5			5.5		pF
C <sub>o</sub>	V <sub>CC</sub> = 5 V,	V <sub>O</sub> = 2.5 V or 0.5 V		7.5			7.5		pF

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

# timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

		V <sub>CC</sub> = T <sub>A</sub> = 2	$V_{CC} = 5 \text{ V},  T_{A} = 25^{\circ}\text{C}$ SN54BCT573			SN74B	UNIT	
		MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>w</sub>	Pulse duration, LE high	4		4		4		ns
t <sub>su</sub>	Setup time, data before LE↓	1		2.5		1		ns
t <sub>h</sub>	Hold time, data after LE↓	4		4		4		ns

<sup>‡</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

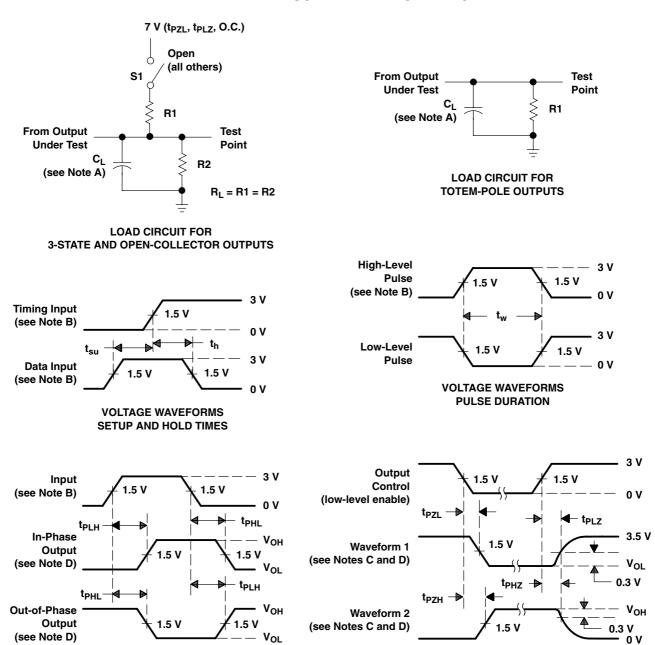
# SN54BCT573, SN74BCT573 OCTAL TRANSPARENT D-TYPE LATCHES WITH 3-STATE OUTPUTS

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switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L$  = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	V,	V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C			CT573	SN74B	UNIT	
	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>		0	2	5	7.2	1	9.8	2	8.4	
t <sub>PHL</sub>	D	Q	2.8	5.9	8.2	1.5	10.3	2.8	9.6	ns
t <sub>PLH</sub>		Q	2.4	6.1	7.2	2	9.7	2.4	8.1	
t <sub>PHL</sub>	LE		Q	2.9	5.2	7.1	2	8.8	2.9	7.8
t <sub>PZH</sub>	OF.	_	3	6.2	8.5	2.5	11	3	10.4	
t <sub>PZL</sub>	ŌĒ	Q	4.3	7.1	9.3	3.5	11.5	4.3	11	ns
t <sub>PHZ</sub>	OF.	0	2.2	3.9	5.6	1.5	7.2	2.2	6	
t <sub>PLZ</sub>	OE Q	l Q	1.7	3.6	5.2	1	7	1.7	6	ns

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

**VOLTAGE WAVEFORMS** 

PROPAGATION DELAY TIMES (see Note D)

(see Note D)

- B. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $t_f = t_f \leq$  2.5 ns, duty cycle = 50%.
- C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- D. The outputs are measured one at a time with one transition per measurement.
- E. When measuring propagation delay times of 3-state outputs, switch S1 is open.
- F. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



0 V

**VOLTAGE WAVEFORMS** 

**ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS** 

www.ti.com 7-Mar-2025

#### PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74BCT573DW	ACTIVE	SOIC	DW	20	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	BCT573	Samples
SN74BCT573N	ACTIVE	PDIP	N	20	20	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74BCT573N	Samples

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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# **PACKAGE OPTION ADDENDUM**

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# PACKAGE MATERIALS INFORMATION

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#### **TUBE**



#### \*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN74BCT573DW	DW	SOIC	20	25	507	12.83	5080	6.6
SN74BCT573N	N	PDIP	20	20	506	13.97	11230	4.32

# N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.





SOIC



#### NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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